

DESCRIPTION

The GLF4010 and GLF4012 are ultra-low I_Q integrated power multiplexer IC with dual independent power switches connected to a single output pin to enable seamless transition between two input sources. The GLF4010 and GLF4012 feature symmetrical power FET characteristics. Channel 1 (VIN1) and channel 2 (VIN2) provide ultra-low conduction resistance to support 6 A continuous current capability. It is an ideal solution for a power system with an internal back up power source.

The GLF4010 and GLF4012 provide an automatic selection mode, a manual selection mode and VIN1 preference mode. The switching of these three modes is executed by combining the S1 and S2 pin settings. The S1 input pin has an internal threshold voltage to offer a preference to select the channel 1 (VIN1) power source. In the automatic input selection mode, the GLF4010 and GLF4012 automatically select a higher input voltage source between two input power sources.

The GLF4010 and GLF4012 prevent cross conduction current between two input sources. When VOUT is higher than VIN, the GLF4012 prevents the reverse current from the output to the input, no matter which input supply is applied.

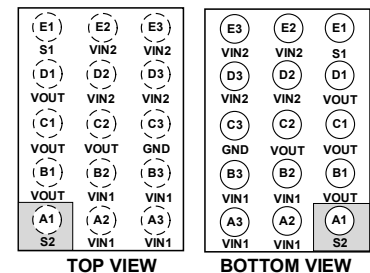
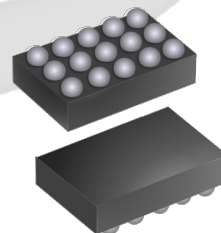
APPLICATIONS

- Smart Door Lock
- Subsystem with Backup Power
- Multi-channel Power Management
- Communication / Network System

FEATURES

- Two-Input and Single-Output Power Multiplexer IC
- Auto & Manual & VIN1 Preference Selection Mode
- Wide Input Range: 1.5 V to 5.5 V
- Low R_{ON}
 - 15 mΩ Typ at 5.5 V_{IN}
- I_{OUT} Max: 6 A Per Channel, VIN1 and VIN2
- Ultra-low Quiescent Current
 - I_Q : 1.4 μA Typ at 5.5 V_{IN}
- Low Shutdown Current
 - I_{SD} : 1.0 μA Typ at 5.5 V_{IN}
- Reverse Current Blocking Protection: Only GLF4012
- Thermal Shutdown Protection
- Wide Operating Temperature Range: - 40 °C to 105 °C

PACKAGE



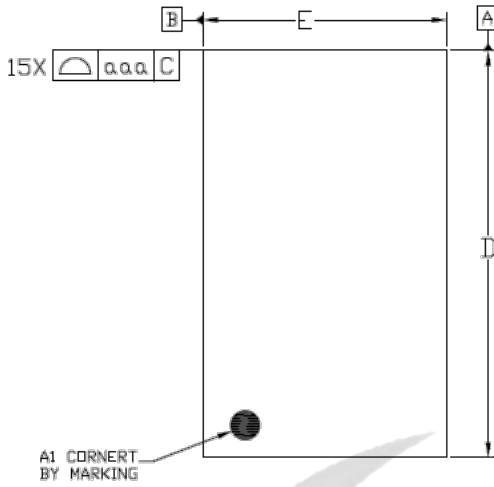
1.17 mm x 1.97 mm x 0.55 mm WLCSP

PRODUCT INFORMATION

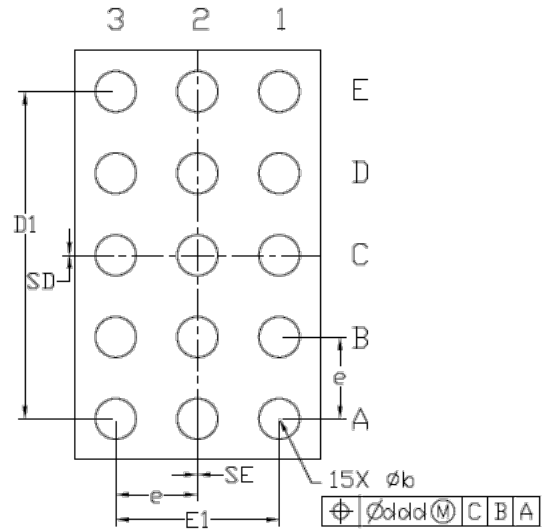
Part Number	Top Mark	R _{ON} (Typ.)	I _{OUT} (Max)	Reverse Current Blocking	Output Discharge (Typ.)	Package	DS Status
GLF4010-SA7	IA	15 mΩ	6 A	NA	NA	1.17 mm x 1.97 mm x 0.55 mm WLCSP	Preliminary
GLF4011-SA7	IB			YES	100 Ω		On Request
GLF4012-SA7	IC			YES	NA		Product



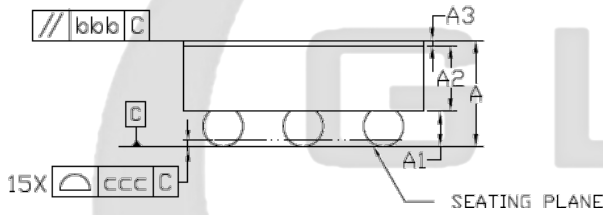
PACKAGE OUTLINE



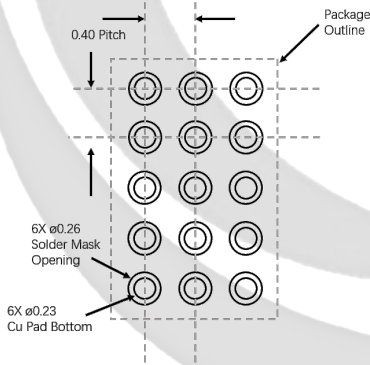
TOP VIEW



BOTTOM VIEW



Recommended Footprint



REF.	Dimensions Ref.		
	Min.	Nom.	Max.
A	0.500	0.550	0.600
A1	0.149	0.175	0.201
A2	0.325	0.350	0.375
A3	0.020	0.025	0.030
D	1.955	1.970	1.985
E	1.155	1.170	1.185
D1	1.550	1.600	1.650
E1	0.750	0.800	0.850
b	0.197	0.232	0.267
e	0.400 BSC		
SD	0.000 BSC		
SE	0.000 BSC		
Tol. of Form & Position			
aaa	0.10		
bbb	0.10		
ccc	0.05		
ddd	0.05		

PACKAGING INFORMATION

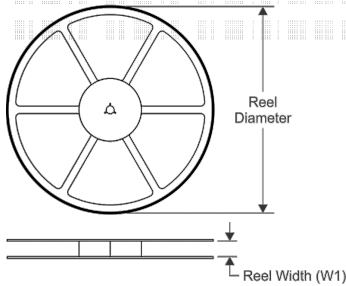
Part Number	Package	Pins	Top Mark	Moisture Sensitivity Level	Environmental Information
GLF4010-SA7	WLCSP	15	IA	MSL1	ROHS+HF
GLF4012-SA7	WLCSP	15	IC	MSL1	ROHS+HF

Notes

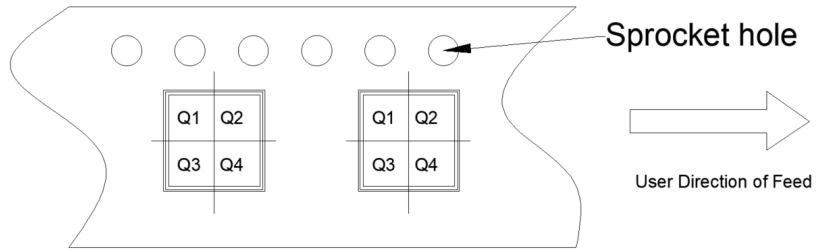
1. ALL DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES)
2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1994.
3. A3: BACKSIDE LAMINATION

TAPE AND REEL INFORMATION

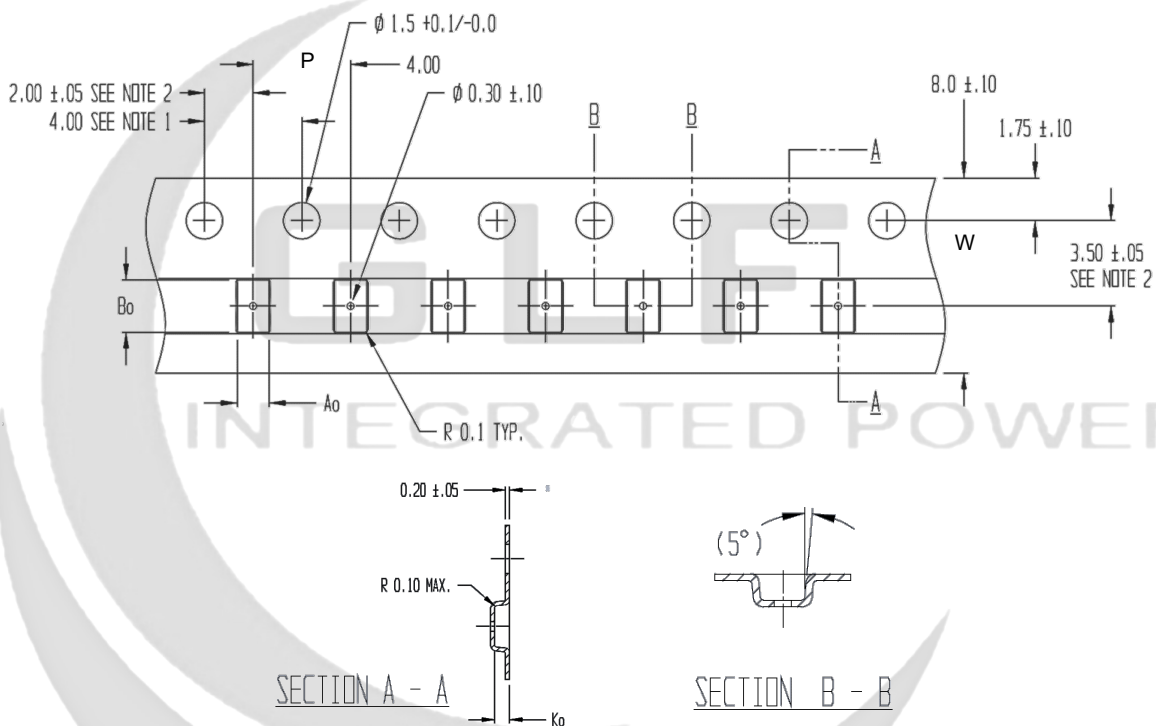
REEL DIMENSIONS



QUADRANT ASSIGNMENTS PIN 1 ORIENTATION TAPE



TAPE DIMENSIONS



Device	Package	Pins	SPQ	Reel Diameter (mm)	Reel Width W1	A0	B0	K0	P	W	Pin1
GLF4010-SA7	WLCSP	15	3000	180	9	1.32	2.15	0.77	4	8	Q2
GLF4012-SA7	WLCSP	15	3000	180	9	1.32	2.15	0.77	4	8	Q2

Remark:

- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- K0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P: Pitch between successive cavity centers